Vishay Sfernice



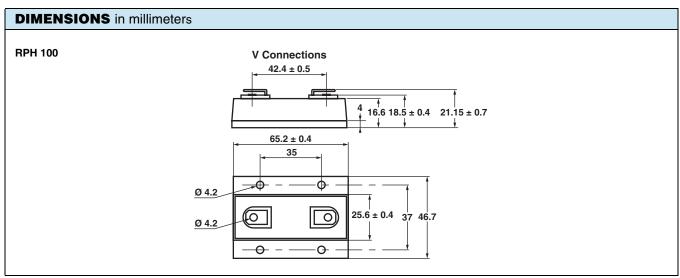
Power Resistor for Mounting onto a Heatsink Thick Film Technology



FEATURES

- High power rating
- Low thermal radiation of the case
- Wide ohmic value range
- Easy mounting
- · High overload capabilities
- · Reduced size and weight
- Compliant to RoHS directive 2002/95/EC

This new style has been developed as an extension to RCH range. Through the use of thick film technology, a non-inductive solution for power resistors is available which are rated up to 100 W at + 25 °C. The terminations position prevents any risk of an electrical arc to the heatsink. This resistor series can replace and offer advantages to standard wirewound devices.



Note

• Tolerance unless otherwise specified: ± 0.3 mm

MECHANICAL SPECIFICATIONS

Mechanical ProtectionInsulated caseSubstrateAlumina on metallicbase of nickel coated

aluminum

Resistive Element Cermet
End Connections V connections:

Screws M4 x 6

Tightening Torque Connections1 NmTightening Torque Heatsink3 NmWeight60 g

ENVIRONMENTAL SPECIFICATIONS

 $\begin{array}{lll} \textbf{Thermal Resistance} & & \mathsf{R}_{\mathsf{TH}\;(j\;\text{-}\;c)}\;0.55\;^\circ\mathsf{C/W} \\ \textbf{Temperature Range} & & -55\;^\circ\mathsf{C}\;\mathsf{to}\;+\;125\;^\circ\mathsf{C} \\ \textbf{Climatic Category} & & 55/125/56 \\ \end{array}$

ELECTRICAL SPECIFICATIONS				
Resistance Range	0.092 Ω to 1 M Ω E24 series			
Tolerances	± 1 % to ± 10 %			
Power Rating:				
Continuous	100 W at 25 °C chassis mounted 0.45 °C/W 10 W at 25 °C free air			
Momentary	400 W at 25 °C for 5 s			
Temperature Coefficient Standard	\pm 300 ppm/°C < 1 Ω \pm 150 ppm/°C > 1 Ω			
Limiting Element Voltage U _L	1900 V _{RMS}			
Dielectric Strength MIL STD 202	5 kV _{RMS} 1 min 10 mA max.			
Insulation Resistance	$> 10^6 \mathrm{M}\Omega$			
Inductance	< 0.1 μΗ			

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PERFORMANCE					
TESTS	CONDITIONS	REQUIREMENTS			
Short Time Overload	NF EN 140000 CEI 115_1 $4 P_{\rm n}/5$ s $U_{\rm S} < 2 U_{\rm L}$ $< \pm (0.25 \% + 0.05 \Omega)$				
Rapid Temperature Change	NF EN 140000 CEI 68214 Test Na 5 cycles - 55 °C + 125 °C	$< \pm (0.25 \% + 0.05 \Omega)$			
Load Life (Chassis Mounted 0.45 °C/W)	NF EN 140000 P _n at 25 °C 1000 h	< ± (0.5 % + 0.05 Ω)			
Humidity (Steady State)	MIL STD 202 Method 103 B Test D 56 days 95 % RH	$< \pm (0.5 \% + 0.05 \Omega)$			

RESISTANCE VALUE IN RELATION TO TOLERANCE AND TCR				
Ohmic Value	< 1 Ω	> 1 Ω		
Standard Tolerance	± 5 %	± 5 %		
Standard TCR	± 300 ppm/°C ± 150 ppm/°C			
Tolerance On Request	± 1 % - ± 2 %			

RECOMMENDATIONS FOR MOUNTING ONTO A HEATSINK

- Surfaces in contact must be carefully cleaned.
- The heatsink must have an acceptable flatness: From 0.05 mm to 0.1 mm/100 mm.
- Roughness of the heatsink must be around 6.3 µm. In order to improve thermal conductivity, surfaces in contact (alumina, heatsink) should be coated with a silicone grease (type SI 340 from Rhône-Poulenc or Dow 340 from Dow Corning).
- The fastening of the resistor to the heatsink is under pressure control of four screws (not supplied).

Tightening Torque on Heatsink	RPH 100
	3 Nm

- In order to improve the dissipation, either forced-air cooling or liquid cooling may be used.
- Do not forget to respect an insulation value between two resistors (dielectric strength in dry air 1 kV/mm).

CHOICE OF THE HEATSINK

The user must choose according to the working conditions of the component (power, room temperature). Maximum working temperature must not exceed 125 °C. The dissipated power is simply calculated by the following ratios:

$$P = \frac{\Delta T}{\left[R_{TH (j-c)} + R_{TH (c-a)}\right]}^{(1)}$$

Expressed in W

Difference between maximum working temperature and room temperature.

R_{TH (i - c)}: Thermal resistance value measured between resistive layer and outer side of the resistor.

It is the thermal resistance of the component: 0.55 °C/W.

R_{TH (c - a)}: Thermal resistance value measured between outer side of the resistor and room temperature.

It is the thermal resistance of the heatsink itself (type, shape) and the quality of the fastening device.

Example:

R_{TH (c - a)}: For RPH 100 power rating 80 W at ambient temperature + 40 °C.

Thermal resistance R_{TH (j - c)}: 0.55 °C/W

Considering equation (1) we have:

$$\begin{split} \Delta T & \leq 125~^{\circ}\text{C} - 40~^{\circ}\text{C} \leq 85~^{\circ}\text{C} \\ R_{TH~(j~c)} + R_{TH~(c~a)} & = \frac{\Delta T}{P} = \frac{85}{80} = 1.06~^{\circ}\text{C/W} \\ R_{TH~(c~a)} & \leq 1.06~^{\circ}\text{C/W} - 0.55~^{\circ}\text{C/W} \leq 0.51~^{\circ}\text{C/W} \end{split}$$

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OVERLOADS

In any case the applied voltage must be lower than 2 $U_{\rm n}$. $U_{\rm max.}$ < 2 $U_{\rm n}$ < 3800 V.

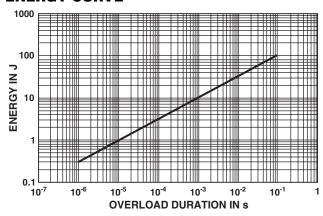
Short time overload: 4 P_n/5 s.

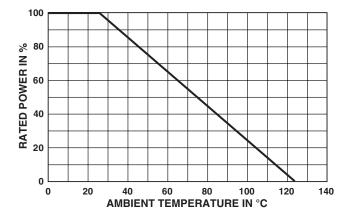
Accidental overload: The values indicated on the graph below are applicable to resistors in air or mounted onto a heatsink.

POWER RATING

For resistor mounted onto a heatsink with thermal resistance of 0.45 $^{\circ}\text{C/W}.$

ENERGY CURVE

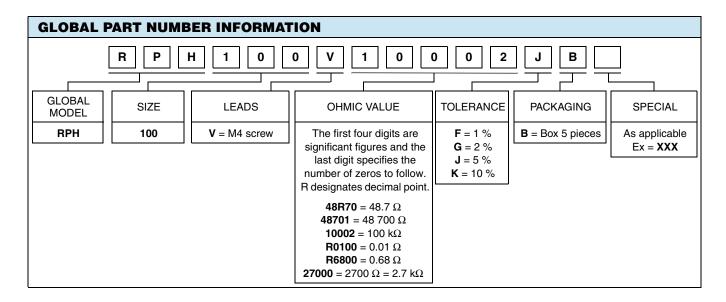




MARKING

Series, style, ohmic value (in Ω). tolerance (in %), manufacturing date, Vishay Sfernice trademark.

ORDERING INFORMATION					
RPH	100	3.3 k Ω	± 5 %	V	xxx
MODEL	STYLE	RESISTANCE VALUE	TOLERANCE	CONNECTIONS	CUSTOM DESIGN
			Optional ± 1 % ± 2 % ± 5 %	V: M4 screw	Options on request TCR, shape, etc.



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